# 16 x 4 Bit Register File (RAM)

The MC10H145 is a 16 x 4 bit register file. The active-low chip select allows easy expansion.

\_\_\_The operating mode of the register file is controlled by the WE input. When WE is "low" the device is in the write mode, the outputs are "low" and the data present at  $D_n$  input is stored at the selected address, when WE is "high," the device is in the read mode — the data state at the selected location is present at the  $Q_n$  outputs.

- Address Access Time, 4.5 ns Typical
- Power Dissipation, 700 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

### **MAXIMUM RATINGS**

Characteristic	Symbol	Rating	Unit
Power Supply (V <sub>CC</sub> = 0)	V <sub>EE</sub>	-8.0 to 0	Vdc
Input Voltage (V <sub>CC</sub> = 0)	VI	0 to VEE	Vdc
Output Current — Continuous — Surge	l <sub>out</sub>	50 100	mA
Operating Temperature Range	T <sub>A</sub>	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T <sub>stg</sub>	-55 to +150 -55 to +165	°C

# **ELECTRICAL CHARACTERISTICS** ( $V_{EE} = -5.2 \text{ V } \pm 5\%$ ) (See Note)

Characteristic	Symbol	<b>0</b> °		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	Onit
Power Supply Current	ΙE		160	1	163	1	165	mA
Input Current High	linH		375	ı	220	1	220	μΑ
Input Current Low	l <sub>inL</sub>	0.5	_	0.5	-	0.3		μΑ
High Output Voltage	Vон	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V <sub>OL</sub>	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	VIH	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V <sub>IL</sub>	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

#### NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 Ifpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts.

# MC10H145



L SUFFIX

CERAMIC PACKAGE CASE 620–10



P SUFFIX

PLASTIC PACKAGE CASE 648-08



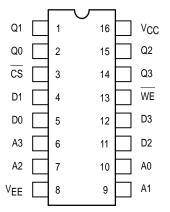
FN SUFFIX PLCC CASE 775–02

#### **TRUTH TABLE**

MODE		ОИТРИТ		
	CS	Qn		
Write "0"	L	L	L	L
Write "1"	L	L	Н	L
Read	L	Н	Х	Q
Disabled	Н	Х	Х	L

Q-State of Addressed Cell

# DIP PIN ASSIGNMENT



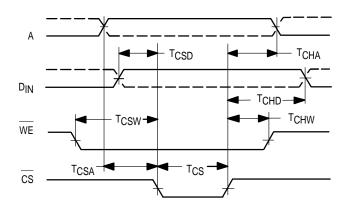
Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6–11 of the Motorola MECL Data Book (DL122/D).

# **AC PARAMETERS**

		MC10H145 T <sub>A</sub> = 0 to +75°C, V <sub>EE</sub> = -5.2 Vdc ±5%			
Characteristics	Symbol	Min	Max	Unit	Conditions
Read Mode Chip Select Access Time Chip Select Recovery Time Address Access Time	tACS tRCS tAA	0 0 0	4.0 4.0 6.0	ns	Measured from 50% of input to 50% of output. See Note 2.
Write Mode Write Pulse Width Data Setup Time Prior to Write Data Hold Time After Write Address Setup Time Prior to Write Address Hold Time After Write Chip Select Setup Time Prior to Write Chip Select Hold Time After Write Write Disable Time Write Recovery Time	tW tWSD tWHD tWSA tWHA tWSCS tWHCS tWS	6.0 0 1.5 3.5 1.5 0 1.5 1.0		ns	$t_{WSA} = 3.5 \text{ ns}$ Measured at 50% of input to 50% of output. $t_{W} = 6.0 \text{ ns}$ .
Chip Enable Strobe Mode Data Setup Prior to Chip Select Write Enable Setup Prior to Chip Select Address Setup Prior to Chip Select Data Hold Time After Chip Select Write Enable Hold Time After Chip Select Address Hold Time After Chip Select Chip Select Minimum Pulse Width Rise and Fall Time	tCSD tCSW tCSA tCHD tCHW tCHA	0 0 0 1.0 0 2.0 4.0	- - - - -	ns	Guaranteed but not tested on standard product. See Figure 1.  Measured between 20% and 80%
Address to Output CS to Output	t <sub>r</sub> , t <sub>f</sub>	0.6 0.6	2.5 2.5	ns	points.
Capacitance Input Capacitance Output Capacitance	C <sub>in</sub> C <sub>out</sub>	_ _ _	6.0 8.0	pF	Measured with a pulse technique.

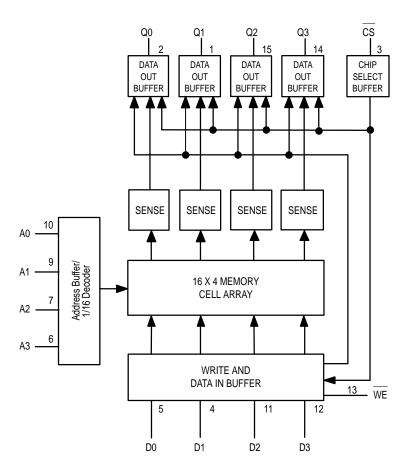
NOTES: 1. Test circuit characteristics: R<sub>T</sub> = 50 Ω, MC10H145. C<sub>L</sub> ≤ 5.0 pF (including jig and Stray Capacitance). Delay should be derated 30 ps/pF for capacitive loads up to 50 pF.
 2. The maximum Address Access Time is guaranteed to be the worst-case bit in the memory.
 3. For proper use of MECL in a system environment, consult MECL System Design Handbook.

# FIGURE 1 — CHIP ENABLE STROBE MODE

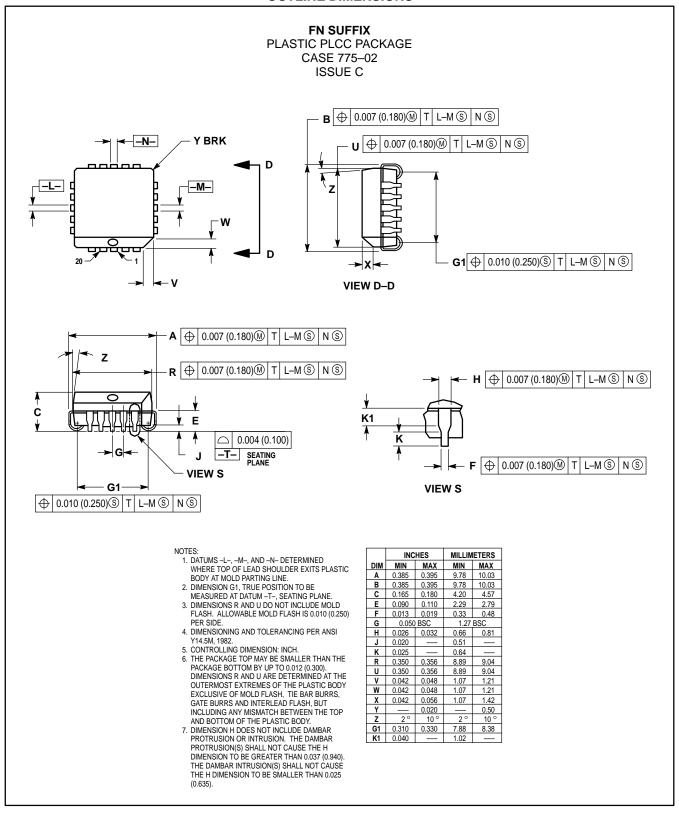


MOTOROLA 2-234

# **BLOCK DIAGRAM**

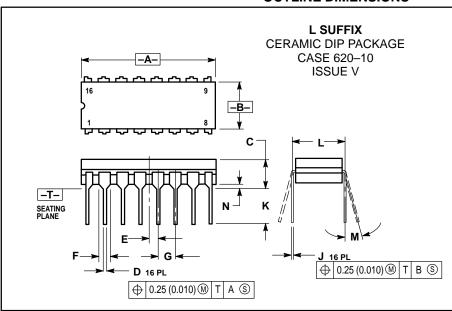


## **OUTLINE DIMENSIONS**



MOTOROLA 2–236

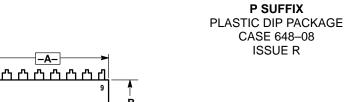
### **OUTLINE DIMENSIONS**

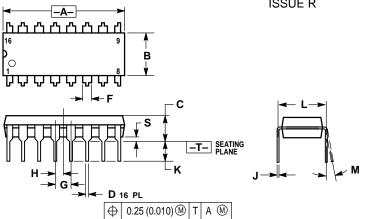


#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
- DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	0.100 BSC		BSC	
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
M	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIM	ETERS		
DIM	MIN	MIN MAX		MAX		
Α	0.740	0.770	18.80	19.55		
В	0.250	0.270	6.35	6.85		
С	0.145	0.175	3.69	4.44		
D	0.015	0.021	0.39	0.53		
F	0.040	0.70	1.02	1.77		
G	0.100 BSC		2.54 BSC			
Н	0.050	0.050 BSC		1.27 BSC		
J	0.008	0.015	0.21	0.38		
K	0.110	0.130	2.80	3.30		
L	0.295	0.305	7.50	7.74		
М	0°	10 °	0°	10 °		
S	0.020	0.040	0.51	1.01		

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MC10H145/D